



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventors: Peter G. Borden and Ji-Ping Li
Assignee: Boxer Cross, Inc.
Title: Identifying Defects In A Conductive Structure Of A Wafer, Based On Heat Transfer Therethrough
Serial No.: 10/090,287 Filing Date: March 1, 2002
Examiner: Verbitsky, Gail Group Art Unit: 2859
Docket No.: BOX014 US Confirmation No.: 6609

Santa Clara, California
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SUBMISSION OF REPLACEMENT DRAWINGS

Dear Sir:

Applicants submit nineteen (19) sheets of drawings, consisting of FIGs. 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11A, 11B, 12, 16, 13, 14, 15, 17, 18, 19, 20, 21, 22, 23, 24, 25, 26, 27, 28, 29, 30, 31, 32, 33 and 34. Please replace all drawings in the above-identified application with the drawings attached hereto.

If there are any questions regarding these drawings, please call the undersigned at (408) 982-8200, extension 3.

**Via Express Mail Label No.
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Respectfully submitted,

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